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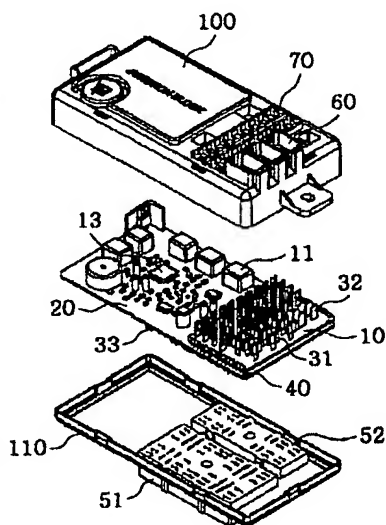
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(54) Title: **INTEGRATED ELECTRONIC MODULE STRUCTURE FOR VEHICLES**



(57) Abstract: Disclosed is an integrated electronic module structure for vehicles that is constructed as an integrated unit using one multi-pole connector for one wire harness. The integrated module structure includes a first printed circuit board (PCB) having fuses, relay circuits, etc., mounted thereon, a second PCB having input/output (I/O) terminals, and a PCB connecting unit for electrically connecting the first and second PCBs. The first and second PCBs are connected through the connector to form the integrated electronic module structure.

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